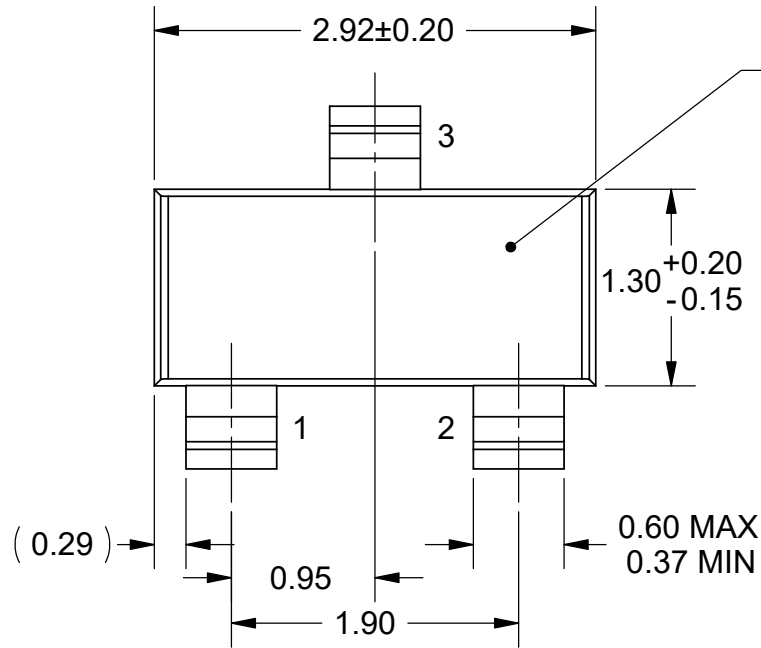
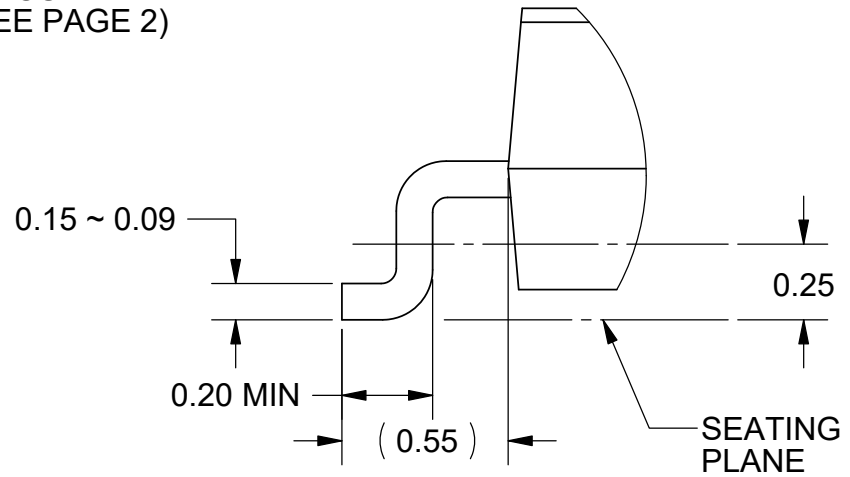


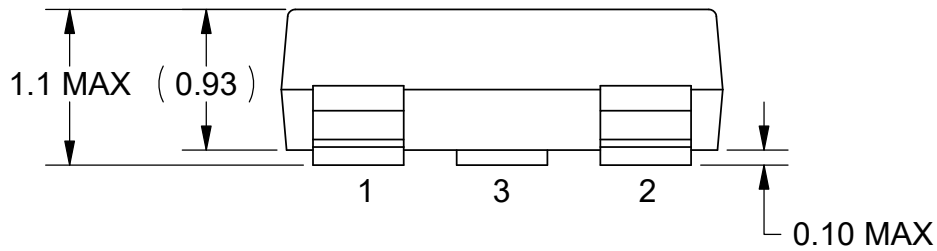
TOP VIEW



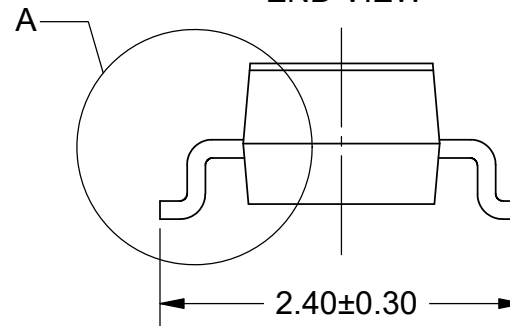
DETAIL A
SCALE 40 : 1



SIDE VIEW


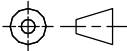


END VIEW

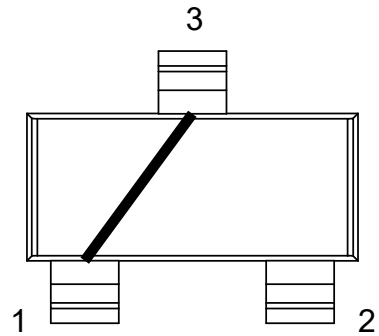


Notes: (Unless Otherwise Specified).

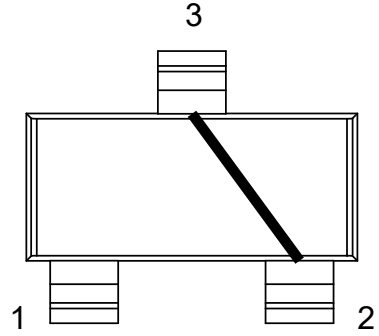
- 1) DIMENSIONS IN mm.
- 2) SEE DAISY CHAIN JUMPER DIAGRAMS (PAGE 2).
- 3) SEE PART NUMBER CONFIGURATION (PAGE 4).
- 4) RECOMMENDED PC BOARD LAYOUT PATTERN (PAGE 7).

TOLERANCE UNLESS NOTED		APPROVALS	DATE				
X.X	+/- 0.3	DRAWN J. Hines	7/14/2016				
X.XX	+/- 0.03		7/14/2016				
X.XXX	+/- 0.003	ENG M. Hart		SCALE 20:1			
ANGLES	+/- 0.5°	MFG					
ALL DIMENSIONS IN		QA		DRAWING NO. 120023			
<input type="checkbox"/> INCHES <input checked="" type="checkbox"/> MILLIMETERS		CUST					
THIRD ANGLE PROJECTION		REVISED		DO NOT SCALE DRAWING			
							

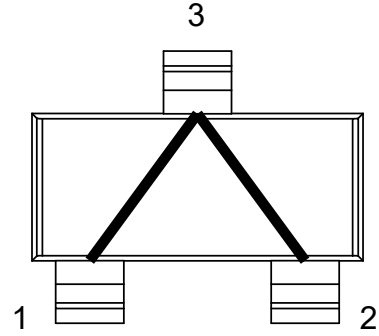
INTERNAL WIRING CIRCUIT (JUMPER)
DAISY CHAIN PART NUMBER SUFFIX
TOP VIEW



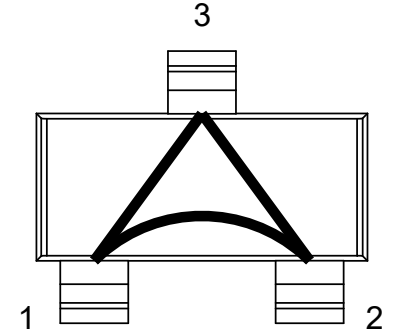
DC13
1-WIRE



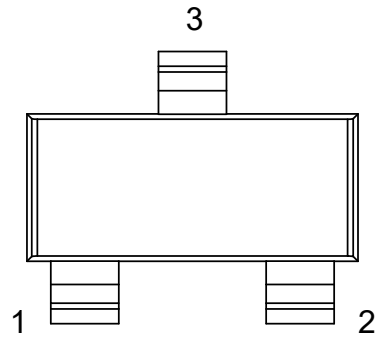
DC23
1-WIRE



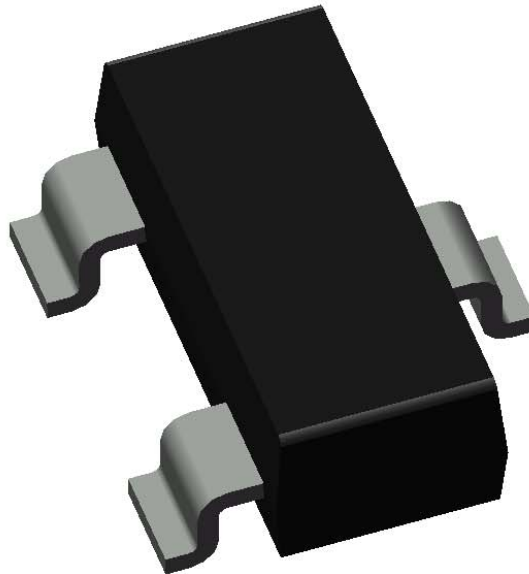
DC123
2-WIRE



DC1231
3-WIRE
SAFETY WIRE
DESIGN

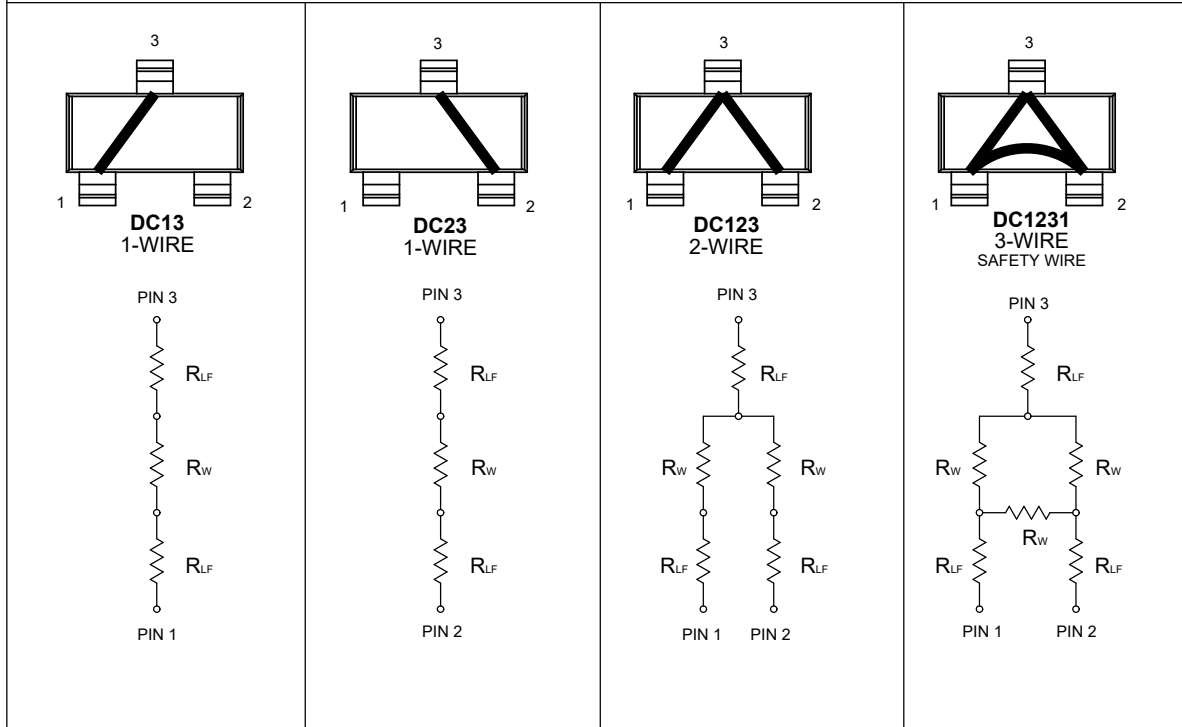


-ISO
NO WIRES
FULLY ISOLATED



TopLine [®]			
TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
25:1	A	120023	A
DO NOT SCALE DRAWING			SHEET 2 OF 8

SCHEMATIC EQUIVALENT INTERNAL CIRCUIT



ELECTRICAL RESISTANCE MILIOHM (DC) MAX			
CIRCUIT	PIN 1 TO 3	PIN 2 TO 3	PIN 1 TO 2
DC13	50 mΩ	--	--
DC23	--	50 mΩ	--
DC123	50 mΩ	50 mΩ	75 mΩ
DC1231	50 mΩ	50 mΩ	50 mΩ

R_W = GOLD WIRE-BOND.
 R_{LF} = LEAD FRAME.

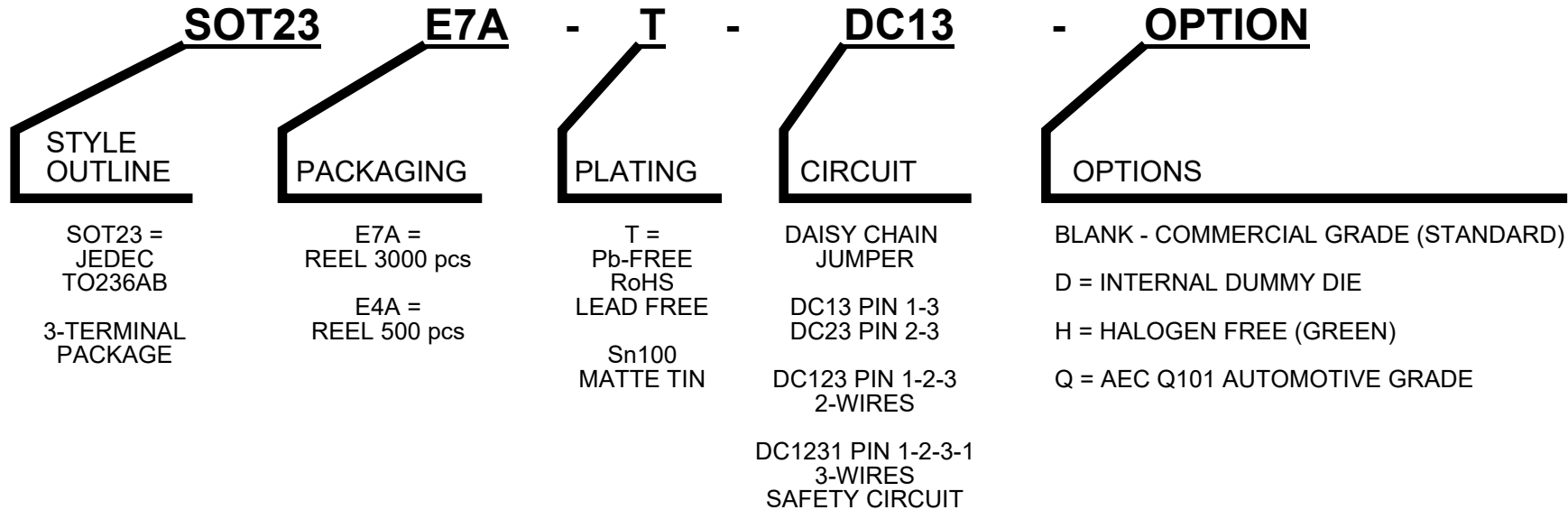
TEMPERATURE RATING	
JUNCTION TEMP T_J	150 °C
STORAGE TEMP T_{stg}	-65 °C TO 150 °C
OPERATING TEMP	-65 °C TO 150 °C
PEAK REFLOW TEMP T_{reflow} 10 SECONDS	260 °C

MAXIMUM ELECTRICAL (DC) RATING	
WORKING VOLTAGE	75 V
CURRENT RATING	100 mA
POWER @ 25 °C	350 mW

THERMAL RESISTANCE	
JUNCTION TO AMBIENT ($T_a=25^\circ$) $R_{th(j-a)}$	350K/W

TopLine ®			
TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
8:1	A	120023	A
DO NOT SCALE DRAWING			SHEET 3 OF 8

PART NUMBERING SYSTEM



ISO = ISOLATED CIRCUIT
NO CONNECTIONS

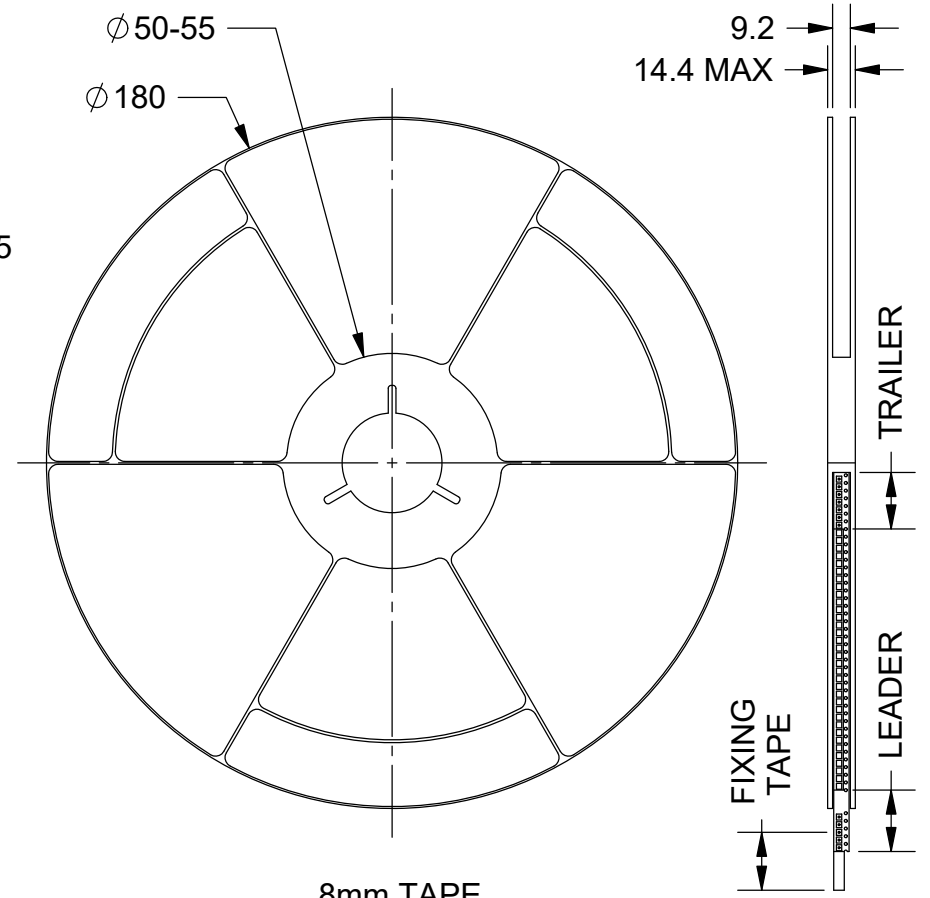
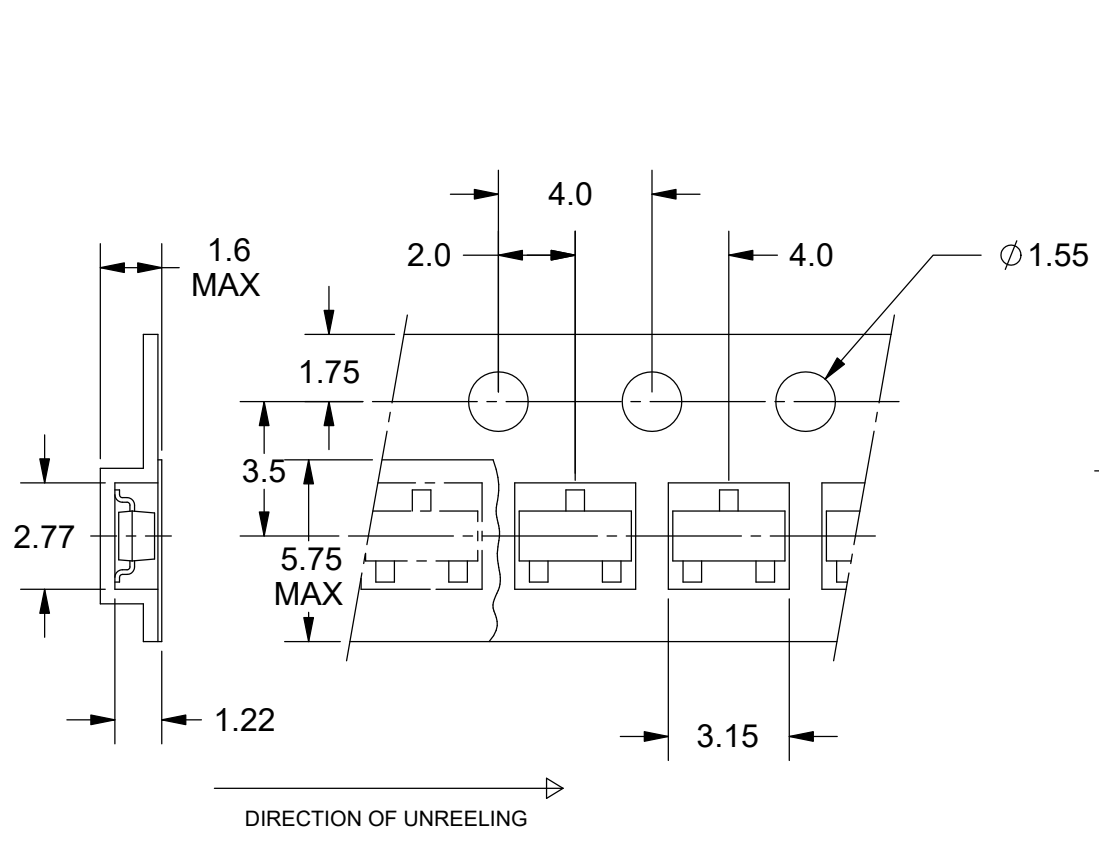
PART NUMBER	SHORTENED PINS	NOTES	RoHS Pb-FREE	MSL LEVEL	HALOGEN FREE	GRADE	TOP MARK
SOT23E7A-TIN	N/A	DUMMY	YES	3	NO	COMMERCIAL	N/A
SOT23E7A-T-ISO	NONE	FULLY ISOLATED	YES	3	NO	COMMERCIAL	ISO
SOT23E7A-T-DC13D	1-3	1-WIRE	YES	3	NO	COMMERCIAL	D13
SOT23E7A-T-DC23D	2-3	1-WIRE	YES	3	NO	COMMERCIAL	D23
SOT23E7A-T-DC123	1-2-3	2-WIRES	YES	3	NO	COMMERCIAL	123
SOT23E7A-T-DC123D	1-2-3	2-WIRES	YES	3	NO	COMMERCIAL	123
SOT23E7A-T-DC13H	1-3	1-WIRE	YES	1	YES	COMMERCIAL	13H
SOT23E7A-T-DC13Q	1-3	1-WIRE	YES	1	NO	AEC-Q101	13Q
SOT23E7A-T-DC13HQ	1-3	1-WIRE	YES	1	YES	AEC-Q101	Q13
SOT23E7A-T-DC23H	2-3	1-WIRE	YES	1	YES	COMMERCIAL	23H
SOT23E7A-T-DC23Q	2-3	1-WIRE	YES	1	NO	AEC-Q101	23Q
SOT23E7A-T-DC23HQ	2-3	1-WIRE	YES	1	YES	AEC-Q101	Q23
SOT23E7A-T-DC1231H	1-2-3	3-WIRES	YES	1	YES	COMMERCIAL	3H
SOT23E7A-T-DC1231Q	1-2-3	3-WIRES	YES	1	NO	AEC-Q101	3Q
SOT23E7A-T-DC1231HQ	1-2-3	3-WIRES	YES	1	YES	AEC-Q101	Q3

NOTES: ADD "D" TO END OF PART NUMBER FOR DUMMY SILICON DIE.

TopLine®			
TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
25:1	A	120023	A
DO NOT SCALE DRAWING			SHEET 4 OF 8

TAPE SPECIFICATION FOR SOT-23
SURFACE MOUNT DEVICE

SOT-23 PACKAGE REEL



8mm TAPE
SIZE OF REEL
180mm (7")
3,000 PCS

ALL DIMENSIONS IN mm

TopLine [®]			
TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
1:1	A	120023	A
DO NOT SCALE DRAWING			SHEET 5 OF 8

MATERIALS CONTENT DECLARATION FORM SOT23 PACKAGE


PART NUMBER OPTION: D, Q, AND BLANK

PART NUMBER OPTION: H AND HQ

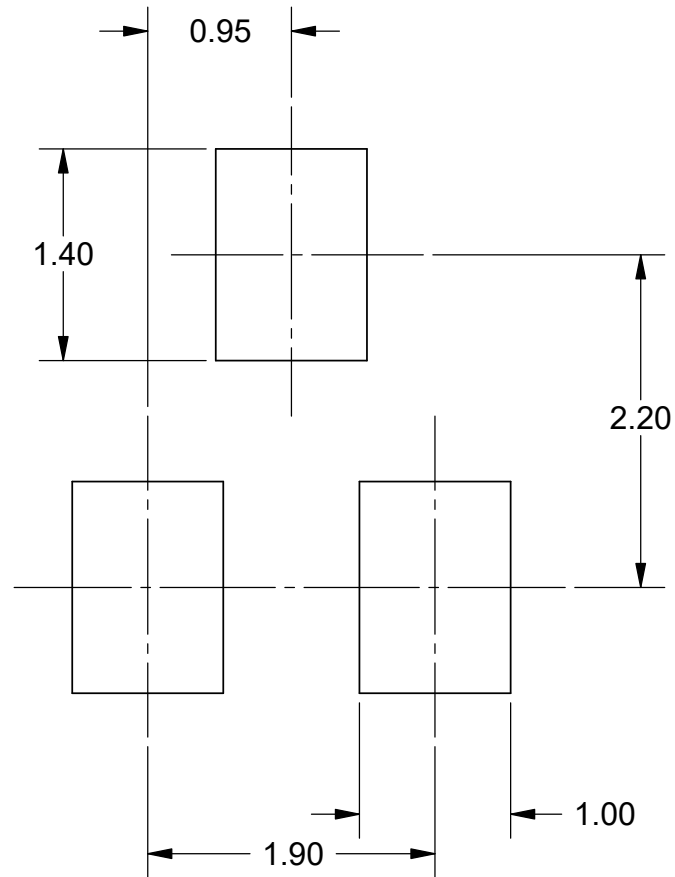
NOTE: EPOXY IS Pb-FREE, RoHS NON-GREEN, NON-HALOGEN FREE					
1 PC WT: 8.8494 mg					
COMPOSITION BREAKDOWN	M.U.M. (MAKE UP OF MATERIALS)	CHEMICAL COMPOSITION	CAS NO	CONTENT (IN %, TOTAL = 100%)	SUBSTANCE WEIGHT (IN mg)
LEADFRAME (2.714 mg)	ALLOY-42	IRON (Fe) NICKEL (Ni) COBALT (Co) COPPER (Cu) SILVER (Ag)	7439-89-6 7440-02-0 7440-48-4 7440-50-8 7440-22-4	20.9 9.0 0.1 0.0 0.7	1.8500 0.7929 0.0050 0.0020 0.0648
CHIP (0.0127 mg)	SILICON	SILICON (Si)	7440-21-3	0.1	0.0127
BONDING WIRE (0.038 mg)	GOLD	GOLD (Au)	7440-57-5	0.4	0.0380
ENCAPSULATION (6.06 mg)	EPOXY RESIN	SILICON DIOXIDE (SiO2) EPOXY ANTIMONY TRIOXIDE (Sb2O3) BROMINATED EPOXY	60676-86-0 29690-82-2 1309-64-4 68928-70-1	48.0 18.5 1.0 1.0	4.2420 1.6360 0.0900 0.0900
TERMINATION PLATING (0.026 mg)	PURE TIN	TIN (Sn)	7440-31-5	0.3	0.0260

NOTE: EPOXY IS GREEN, HALOGEN FREE, Pb-FREE, RoHS					
1 PC WT: 8.8494 mg					
COMPOSITION BREAKDOWN	M.U.M. (MAKE UP OF MATERIALS)	CHEMICAL COMPOSITION	CAS NO	CONTENT (IN %, TOTAL = 100%)	SUBSTANCE WEIGHT (IN mg)
LEADFRAME (2.714 mg)	ALLOY-42	IRON (Fe) NICKEL (Ni) COBALT (Co) COPPER (Cu) SILVER (Ag)	7439-89-6 7440-02-0 7440-48-4 7440-50-8 7440-22-4	20.9 9.0 0.1 0.0 0.7	1.8500 0.7929 0.0050 0.0020 0.0648
CHIP (0.0127 mg)	SILICON	SILICON (Si)	7440-21-3	0.1	0.0127
BONDING WIRE (0.038 mg)	GOLD	GOLD (Au)	7440-57-5	0.4	0.0380
ENCAPSULATION (6.06 mg)	EPOXY RESIN	SILICON DIOXIDE (SiO2) EPOXY *PROPRIETARY FLAME RETARDANT	60676-86-0 29690-82-2 ---	48.0 18.5 2.0	4.2420 1.6360 0.1800
TERMINATION PLATING (0.026 mg)	PURE TIN	TIN (Sn)	7440-31-5	0.3	0.0260

* PROPRIETARY HYDROXIDE OF MAGNESIUM AND ALUMINUM.

			
TITLE SOT23 JUMPER DAISY CHAIN			
SCALE 1:1	SIZE A	DRAWING NO. 120023	REV A
DO NOT SCALE DRAWING			SHEET 6 OF 8

PC BOARD LAND PATTERN



Notes: (Unless Otherwise Specified).

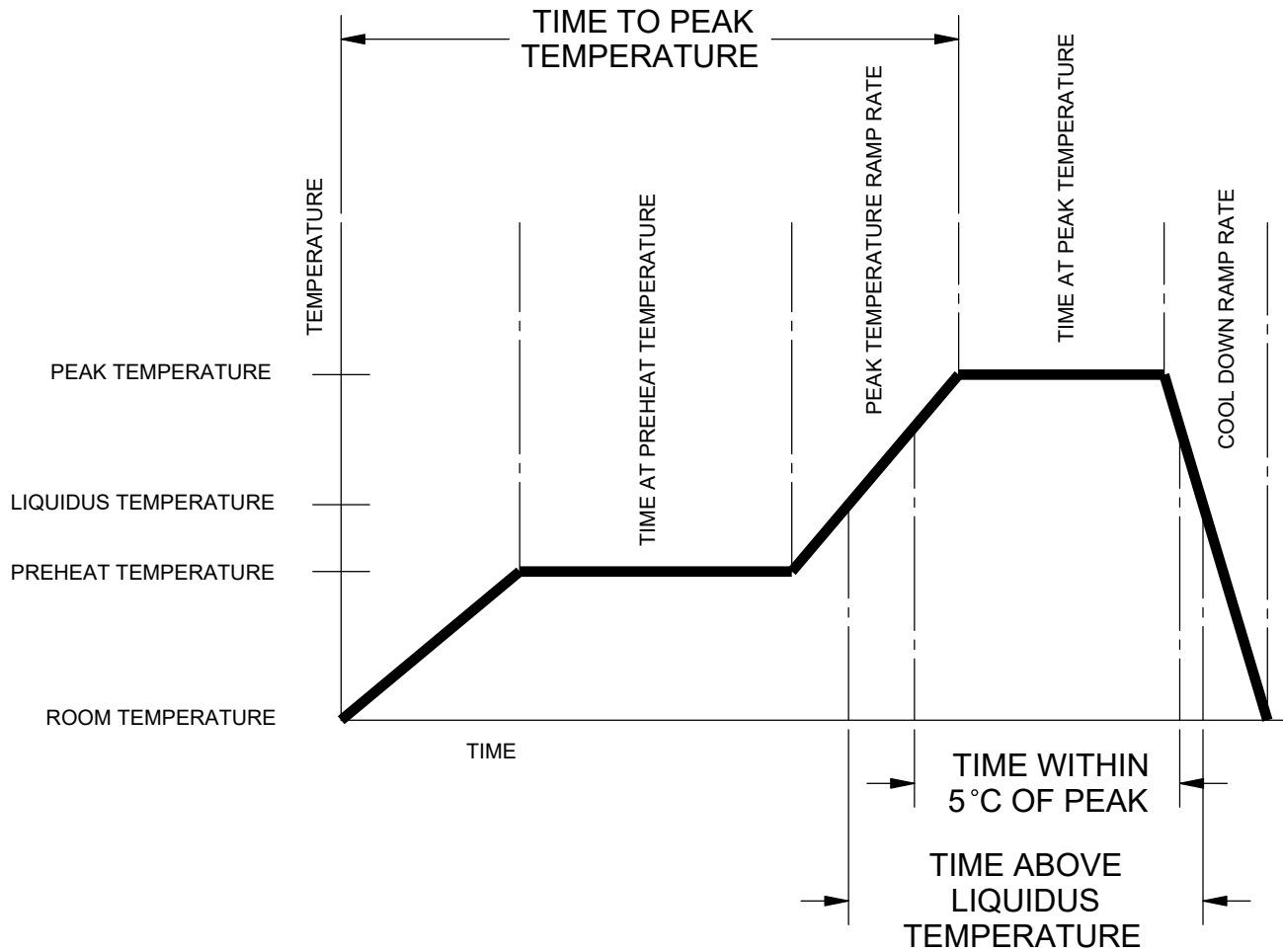
1) DIMENSIONS IN mm.

2) PCB BOARD DIMENSIONS ARE PRESENTED ONLY AS A GUIDELINE.
DESIGNERS SHOULD USE THEIR OWN EXPERIENCE WHEN DESIGNING PCB.

TopLine[®]

TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
20:1	A	120023	A
DO NOT SCALE DRAWING		SHEET 7 OF 8	

LEAD FREE REFLOW PROFILE OF SMT PACKAGE



DESCRIPTION	REQUIREMENT
AVERAGE PREHEAT RAMP RATE	3°C /SECOND MAXIMUM
PREHEAT TEMPERATURE	150°C MINIMUM, 200°C MAXIMUM
PREHEAT TIME	60 TO 80 SECONDS
RAMP TO PEAK	3°C /SECOND MAXIMUM
TIME OVER LIQUIDUS (217°C)	60 TO 150 SECONDS
PEAK TEMPERATURE	260°C +0/-5°C
TIME WITHING 5°C OF PEAK	20 TO 40 SECONDS
RAMP - COOL DOWN	6°C /SECONDS MAXIMUM
TIME 25°C TO PEAK	8 MINUTES MAXIMUM

TopLine [®]			
TITLE		SOT23 JUMPER DAISY CHAIN	
SCALE	SIZE	DRAWING NO.	REV
1:1	A	120023	A
DO NOT SCALE DRAWING			SHEET 8 OF 8